

7A 600V N-channel Enhancement Mode Power MOSFET

1 Description

These N-channel enhanced vdmosfets, is obtained by the self-aligned planar technology which reduce the conduction loss, improve switching performance and enhance the avalanche energy. Which accords with the RoHS standard. TO-220F provides insulation voltage rated at 2000V RMS from all three terminals to external heatsink. TO-220F series comply with UL standards (File ref:E252906).

2 Features

- Fast switching
- ESD improved capability
- Low on resistance(Rdson≤1.25Ω)
- Low gate charge(Typ: 24nC)
- Low reverse transfer capacitances(Typ: 5.5pF)
- 100% single pulse avalanche energy test
- 100% ΔVDS test
- 3 Applications
- Used in various power switching circuit for system miniaturization and higher efficiency.
- Power switch circuit of electron ballast and adaptor.

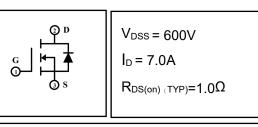
4 Electrical Characteristics

4.1 Absolute Maximum Ratings (Tc=25°C, unless otherwise noted)

PARAMETER		SYMBOL	VALUE	UNIT			
Drian-Source Voltage		V _{DS}	600	V			
Gate-Source Voltage		V _{GS}	±30	V			
Drain Current(continuous) ^(Note 3)		ID	7	А			
Drain Current(continuous)(T=100 °C) ^(Note 3)		I _D	4.4	А			
Drain Current(Pulsed)		I _{DM}	28	А			
Single Pulse Avalanche Energy ^(Note 4)		E _{AS}	400	mJ			
Derating Factor above	T _a =25℃	D	0.28	W			
Power Dissipation	Tc=25℃	- P _D	35	W			
Operating Junction Temperature Range		Tj	-55~150	°C			
Storage Temperature Range		T _{stg}	-55~150	°C			
High Temperature(tin solder)		TL	300	°C			

4.2 Thermal Characteristics

PARAMETER	SYMBOL	VALUE	UNIT
Thermal Resistance, Junction to Case-sink	R _{thJC}	3.57	°C/W
Thermal Resistance, Junction to Ambient	R _{thJA}	62.5	°C/W







4.3 Electrical Characteristics	(Tc=25 ℃,	unless otherwise noted)				
PARAMETER	SYMBOL	Test Condition	VALUE			UNIT
			MIN	TYP	MAX	UNIT
Off Characteristics	1	1				
Drain-source Breakdown Voltage	BV _{DSS}	I _D =250µA,V _{GS} =0V	600			V
	l	V _{DS} =600V,V _{GS} =0V, T _C =25℃			1	μA
Zero Gate Voltage Drain Current	IDSS	V _{DS} =480V,V _{GS} =0V, T _C =125℃			100	μA
Gate-to-Body Leakage Current	I _{GSS}	V _{GS} =±30V,V _{DS} =0V			±100	nA
On Characteristics ^(Note 3)		-				
Gate threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	2.0		4.0	V
Drain-source on Resistance	R _{DS(on)}	V _{GS} =10V,I _D =3.5A		1.0	1.25	Ω
Dynamic Characteristics						
Input Capacitance	Ciss			1121		pF
Output Capacitance	Coss	V _{GS} =0V,V _{DS} =25V, f=1.0MHz		96		
Reverse Transfer Capacitance	Crss	1-1.00012		5.5		
Turn-on Delay Time	T _{d(on)}			18		
Turn-on Rise Time	tr	ID=7A, VDD=300V,		22		ns
Turn-off Delay Time	T _{d(off)}	VGS=10V, RG=10Ω		40		
Turn-off Fall	t _f			19		
Total Gate Charge	Qg	ID=7A,VDD=480V,		24		
Gate-to-Source Charge	Q _{gs}	VGS=10V		4.8		nc
Gate-to-Drain("Miller")C harge	Q _{gd}	VGS=10V		9.5		
Drain-Source Diode Characteristics						
Diode Forward Voltage ^(Note 3)	V _{FSD}	V _{GS} =0V,I _S =7A			1.5	V
Continuous Source Current (BodyDiode) ^(Note 3)	ls				7	А
Reverse Recovery Time	trr	TJ=25℃ ,IF=7A,		363		ns
Reverse Recovery Charge	Qrr	dIF/dt=100A/µS,VGS=0V		1920		nc

Notes:

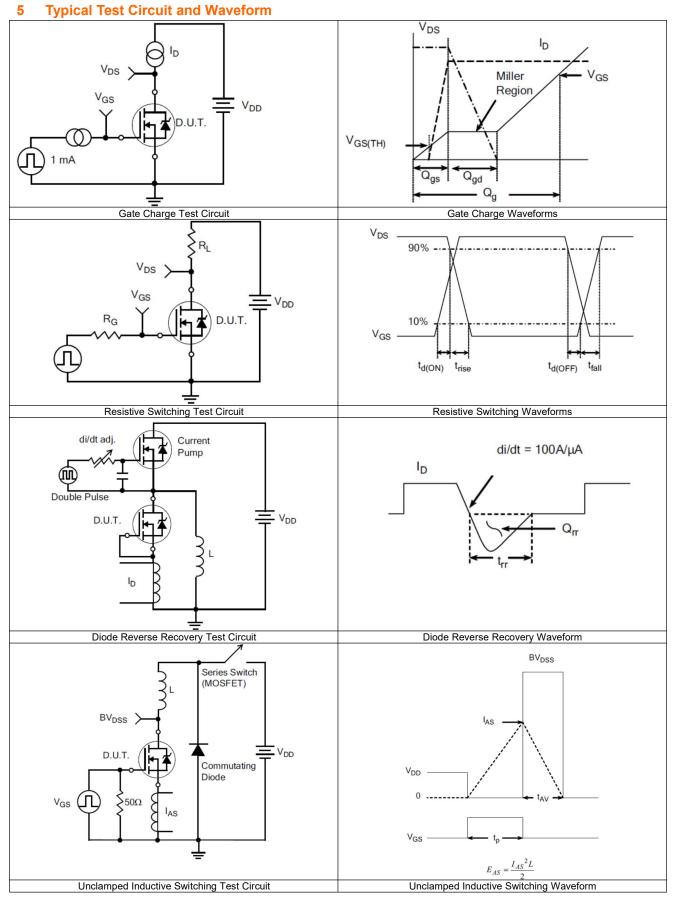
1: Repetitive rating, pulse width limited by maximum junction temperature.

2: Surface mounted on FR4 Board, t≤10sec.

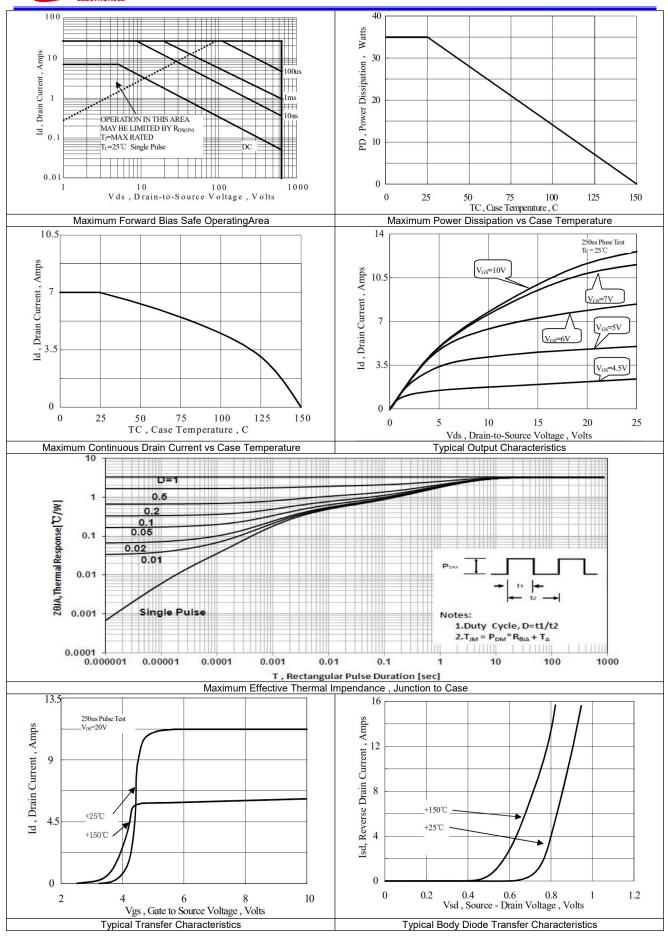
3: Pulse width \leq 300µs, duty cycle \leq 2%.

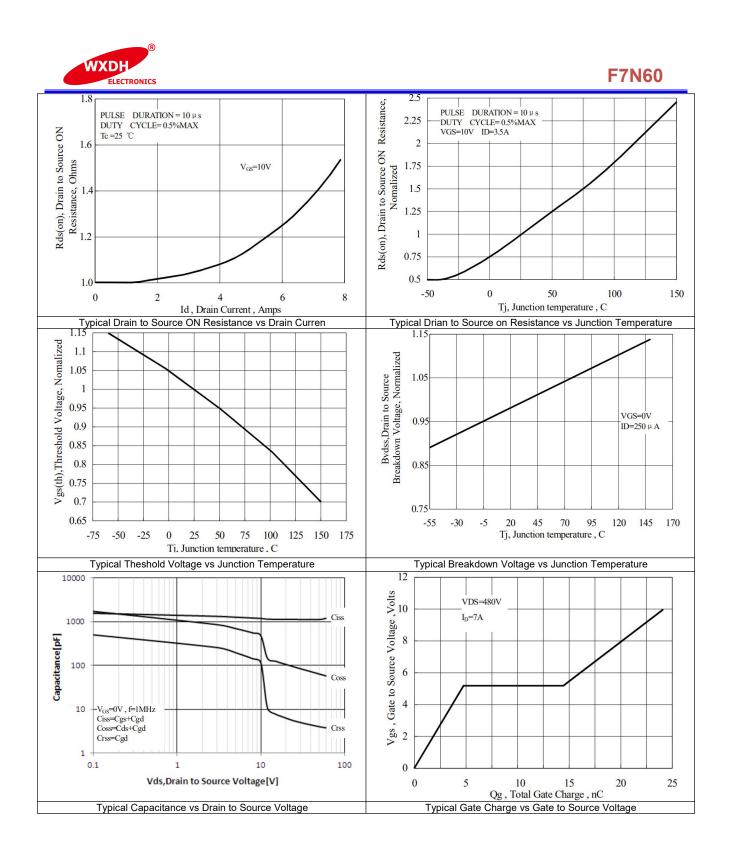
4: L=10mH,I_D=9.0A,V_DD=50V,,Start T_J=25 $^\circ\!\mathbb{C}.$









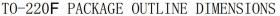


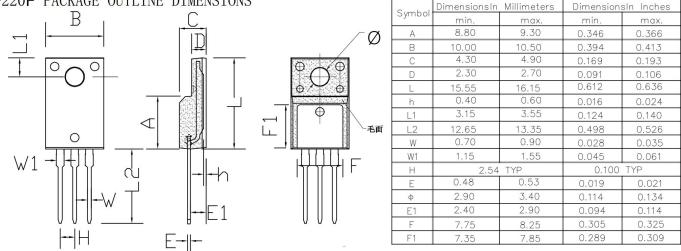


6 Product Specifications and Packaging Models

Product Model	Package Type	Mark Name	RoHS	Package	Quantity
F7N60	TO-220F	F7N60	Pb-free	Tube	1000/box

7 Dimensions





8 Attentions

- Jiangsu Donghai Semiconductor Technology Co., Ltd. reserves the right to change the specification without prior notice! The customer should obtain the latest version of the information before making the order and verify that the information is complete and up to date.
- It is the responsibility of the purchaser for any failure or failure of any semiconductor product under certain conditions. It is the responsibility of the purchaser to comply with safety standards and to take safety measures in the system design and machine manufacturing of WXDH products in order to avoid potential risk of failure. Injury or property damage.
- Product promotion is endless, our company will be dedicated to provide customers with better products.

9 Appendix

Revision history:

Date	REV.	Description	Page
2020.03.09	1.0	Original	